IPC ASSOCIATION CO	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bounder and Pan-American copyright conventions.		der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lo level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfc Information				
upplier Ir	nformation	,												
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi										2024-05-04				
Contact Nam	e	Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env	y-Stewards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorized R	Representative*	Title - Representative			F	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Ro	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	. I	Manufacturing Site	V	eight*	UOM	Unit Type
		NTTFS030N10GTAG 100V MVSOA ii		100V MVSOA in u	18FL package	;	2024-05-04 MY1		MY1	2'	7.452936	mg	Each	
	uring Proccess Informa													·
			Terminal Base Alloy J-STD-020 MSL		L Rating				Temperatu	re Numbe	r of Reflow Cyc	cles		
Ma	atte Tin (Sn) - annealed		CU Alloy	1			260		C	30	second	s 3		
omments														
vel 1 - maxi	mum time at peak tempera	ture during sol	dering is 10-3	0 seconds										
or more info	ormation regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-6_									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	0.378234	mg	Supplier	Zinc (Zn)	7440-66-6		0.0005	mg
			Supplier	Iron (Fe)	7439-89-6		0.0089	mg
			Supplier	Copper (Cu)	7440-50-8		0.3688	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0001	mg
Die	0.152807	mg	Supplier	Silicon (Si)	7440-21-3		0.1528	mg
Lead Frame	11.4444	mg	Supplier	Silver (Ag)	7440-22-4		0.2197	mg
			Supplier	Iron (Fe)	7439-89-6		0.0103	mg
			Supplier	Copper (Cu)	7440-50-8		11.2132	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0011	mg
Mold Compound-Black	12.6623	mg		Epoxy resin	proprietary data		0.9497	mg
			Supplier	Phenolic Resin	Proprietary Data		0.3166	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.9497	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0633	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.3831	mg
Plating	0.951436	mg	Supplier	Tin (Sn)	7440-31-5		0.9514	mg
Solder Paste	1.84959	mg	Supplier	Silver (Ag)	7440-22-4		0.0462	mg
			A	Lead (Pb)	7439-92-1	7a	1.7109	mg
			Supplier	Tin (Sn)	7440-31-5		0.0925	mg
Wire Bond - Cu	0.01417	mg	Supplier	Copper (Cu)	7440-50-8		0.0142	mg